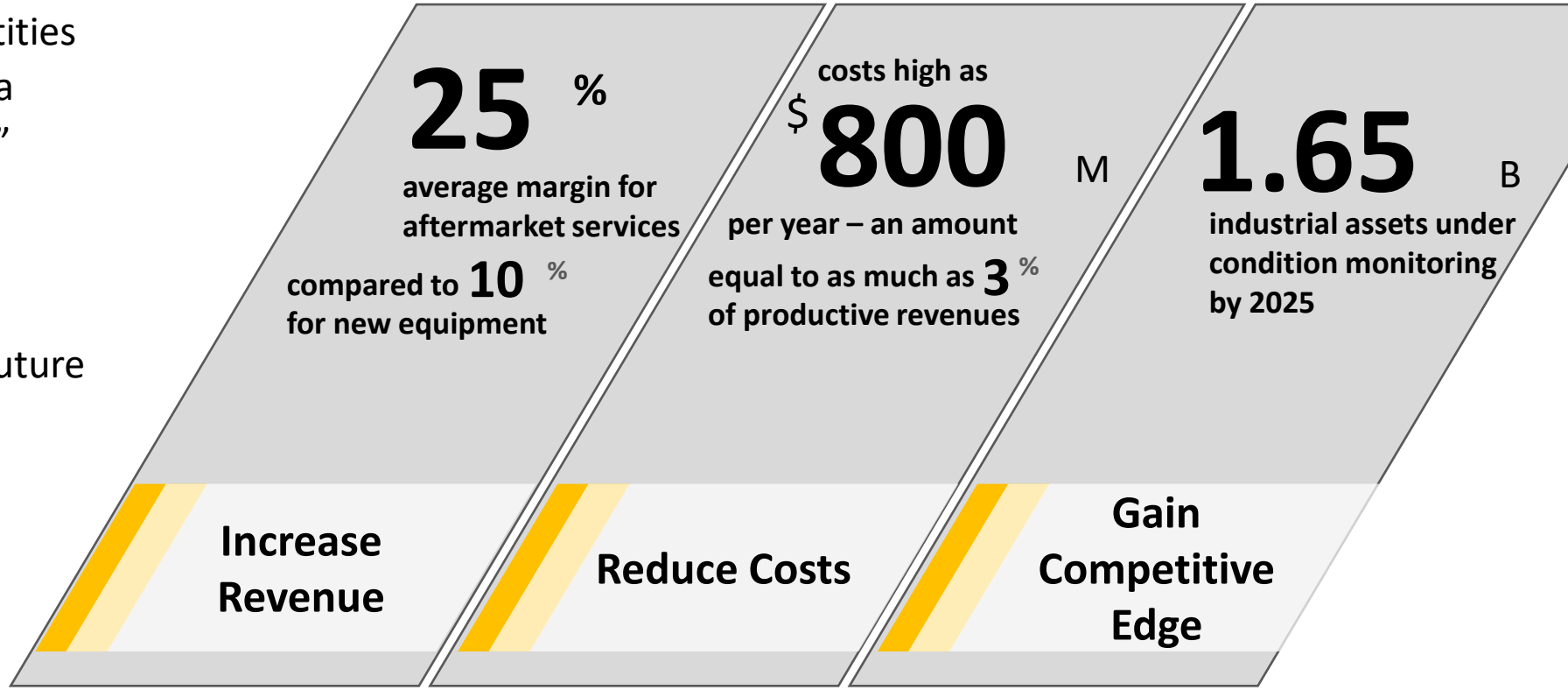
Release 2023 R1 Highlights
Ansys Twin Builder

What is a Digital Twin?

Past, Present, Future, Simulate!

digital twin CONSORTIUM : "Virtual representation of real-world entities and processes, synchronized at a specified frequency and fidelity"

Customer Value: Track the past, provide deeper insights into the present, predict and influence future behavior



Sources:
1. "Industrial aftermarket services: Growing the core.", McKinsey.com
2. "Controlling Warranty Costs by Preventing No Fault Found", WIKA Group
3..Total addressable market (TAM) and compound annual growth rate (CAGR) information throughout presentation is based on third party study completed by Evaluserve Inc. in 2019 commissioned by ANSYS. Study was based on customer and industry expert interviews and review of industry analyst reports and commentaries. Refer to Cautionary Statement for a discussion of factors that could impact future financial results.

Ansys Leading the Way in Global Digital Twin Initiatives

Digital Twin Consortium

- Ansys is one of 8 founding members

digital twin™ CONSORTIUM

Ansys AUTODESK. Bentley DELL Technologies

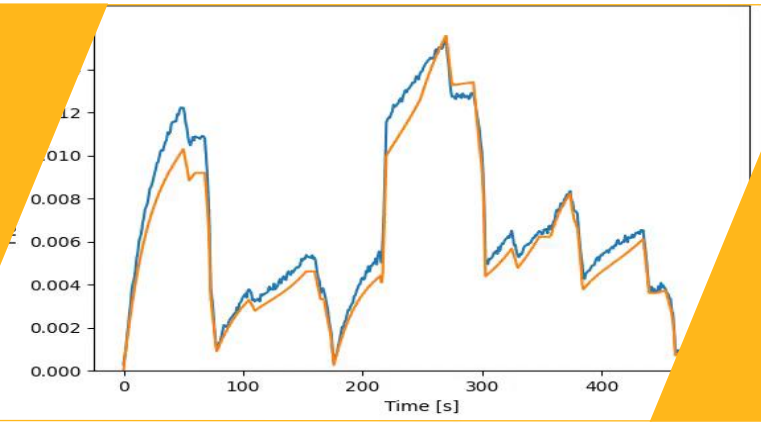
GE Digital lendlease Microsoft NORTHROP GRUMMAN

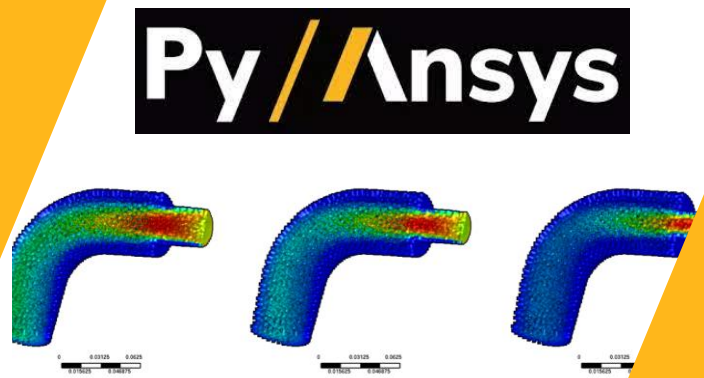
- Drives the development and adoption of digital twin technologies
- Emerging standards body (part of OMG)

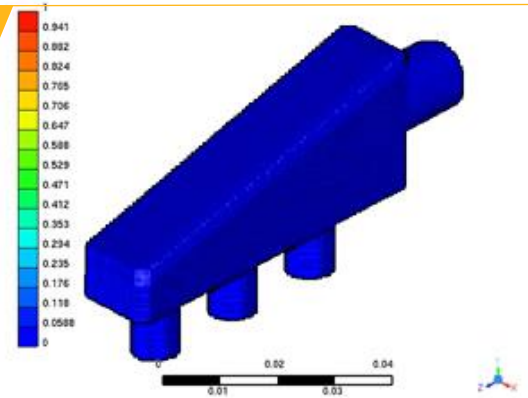
Digital Twin Definition Language (DTDL)

- Ansys and Microsoft collaborating on DTDL and on developing reusable reference architecture
- Enabling IoT solutions to provision, use, and configure IoT devices from multiple sources in a single solution

Accurate & Evolving Digital Twins with Twin Builder Hybrid Analytics







Increase Digital Twin Prediction Accuracy with Hybrid Analytics

- ✓ Model Exchange FMU support with new solver in Twin Deployer improves **interoperability and simulation stability**
- ✓ Improved documentation and API examples make it **easier to get started with deployment**
- ✓ Automate Runtimes deployment in Python with **PyTwin**

Automation, Speed & Accuracy for ROM creation

- ✓ **New Linear Static and Dynamic** ROMs offer **faster and more accurate** ROMs for a variety of applications
- ✓ Improved ROM visualization with the ability to generate ROM images with **geometry deformation**
- ✓ **Automate your ROM** creation with PyAEDT, which now includes new examples for creating static and dynamic ROMs

Enhanced Solver and Model Library and User Experience

- ✓ Improvements to **Modelica Editor Bijection** (Text-to-Diagram) support, which allows users to switch between text and diagram views for easier model creation
- ✓ **Easier workflow with "Wire Together“,** which allows for easier pin connection for components with large numbers of pins
- ✓ **Create and Export videos** from your ROM images for better visualization

Innovations in Ansys Digital Twin 2023 R1

Transform Your Operations with Data-Driven and Simulation-Based Digital Twin Software

Export and Scaled Deployment

- Support for Hierarchical Parameters in the Model Parameter Dialog
- **Model Exchange (ME) FMU Support in Twin Deployer**
- **Examples of Simpler Scaffolding Code** for Easier API Understanding
- Improved ROM Image Generation Support in the Deployment Package
- **New Improved API Documentation**
- Several Enhancements and Bug-Fixes
- **Automate Runtimes deployment in Python with PyTwin**

Reduced Order Model

- **New Linear Static ROM with Support for Large Number of Parameters**
- **New Linear Dynamic ROM**
- Cut-plane coordinate Specification by Orientation and Origin
- Improved Workflow for Renaming Input/Output Pins for ROMs
- **Image Generation with Geometry Deformation**
- Improvements on modal ROM export from Mechanical

Model Building-Modelica Enhancements

- **Modelica Editor Bijection (Text-to-Diagram) support**
- Modelica Enhanced Diagram Graphics
- Support for Hierarchical Display and Editing of Parameters

Solver and Model Library

- Usability Improvements for Device Characterization Wizard
- Support for Gradient Fitting in Device Characterization
- New Basic Dynamics MOSFET Model with Q3 control (Beta)
- Carrier Wave Options in the SVPWM Component

General Enhancements

- **Easier Pin Connection for Large Components**
- **Twin Builder ROM Animation Video Export**
- **Example of ROM creation using PyAnsys**
- Easy Debug and Error Log Access

Hybrid Digital Twin

Challenges in Creating a Digital Twin

Digital Twin Goals: Accuracy, Time, and Cost

Customers are demanding more from their products, pressuring manufacturers to produce faster, better, and more reliable designs

Data and simulation approaches each make reasonable predictions, but also both face limitations

Data-Driven Modeling

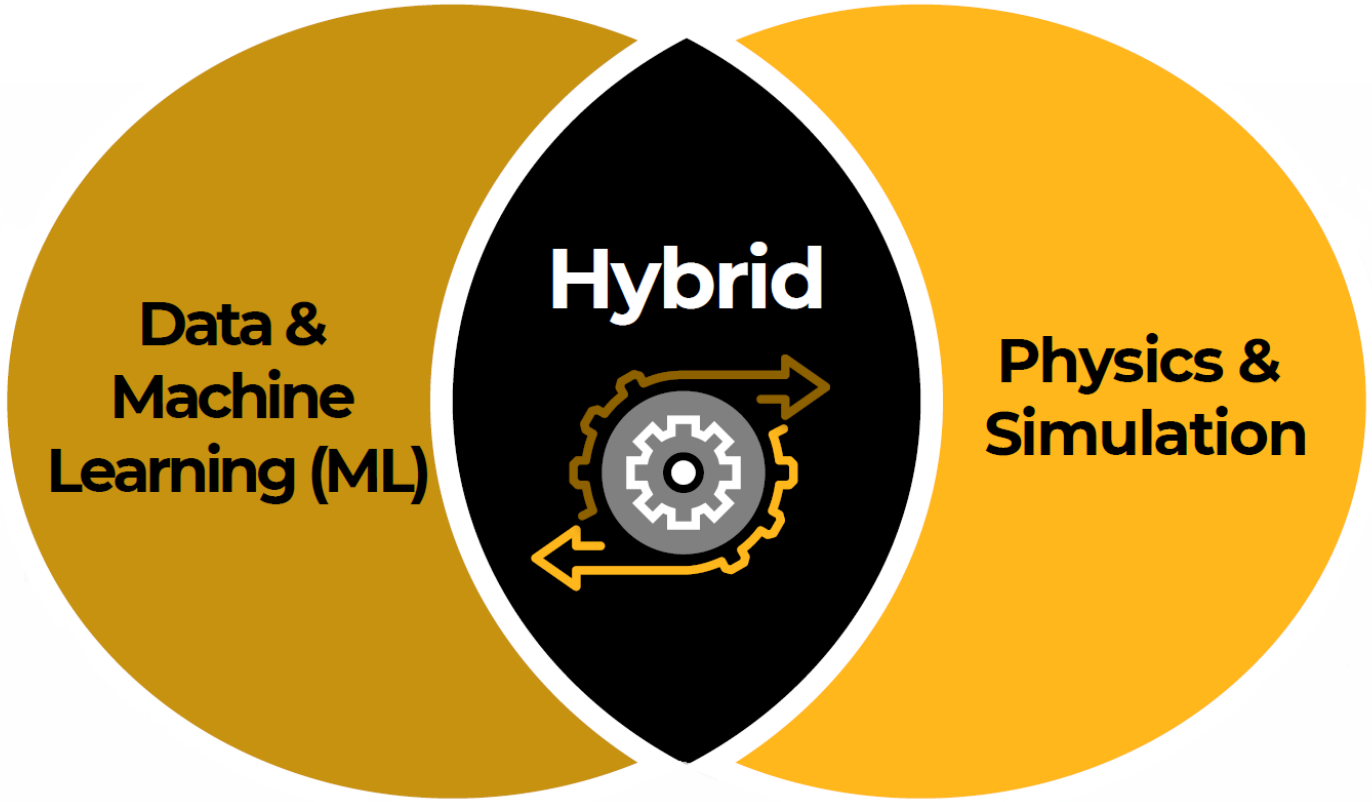
Accuracy limited by observed data

Simulation-Based Modeling

Missing real-time field insights

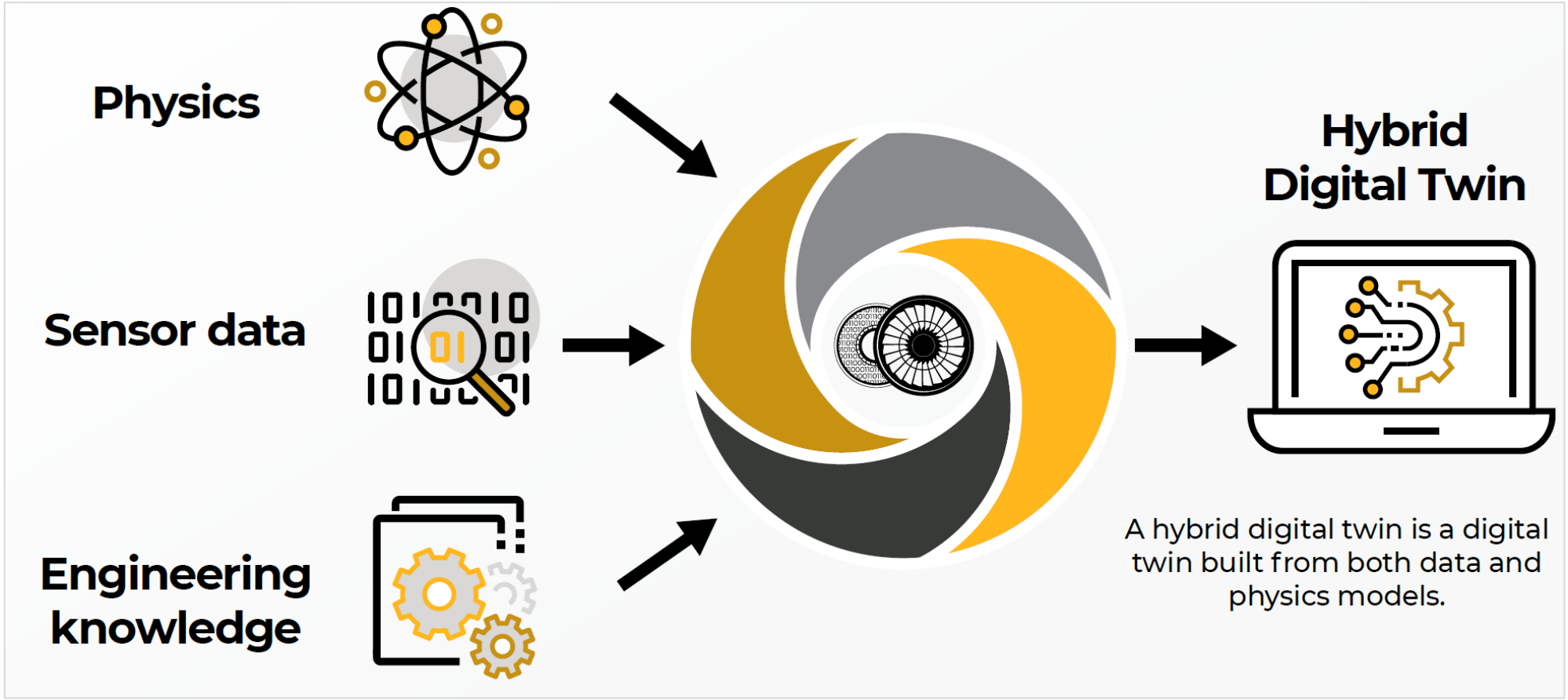
The Solution: Hybrid Digital Twins, the Best of Machine Learning and Physics

Hybrid Analytics is a toolset for combining data and physics modeling using machine learning techniques to create Hybrid Digital Twins



How Does it Work?

Combine data and physics to create the best possible digital twins



Hybrid Analytics Techniques

Data Enhancing Physics Simulation

- Parameter Estimation
- Uncertainty Quantification

Simulation Enhancing ML Models

- Virtual Sensors
- Explore Failure Modes

Full Integration

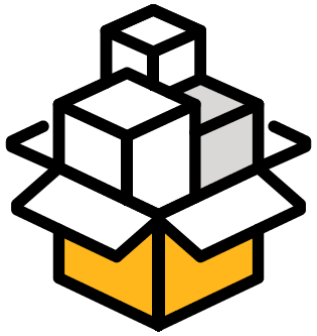
Fusion Model: Build models from both data and physics

Hybrid Analytics Capabilities

Transform your operations with data-driven and simulation-based digital twin software

Unparalleled Accuracy

Closely match simulation results with measurement data by calibrating model parameters



Uncertainty Quantification

Uncertainty quantification on parameters and outputs provides confidence in fit

Fusion Modeling

Compensate for any unmodeled physics or other effects by modeling the difference between a physics model and data

Robust Algorithms

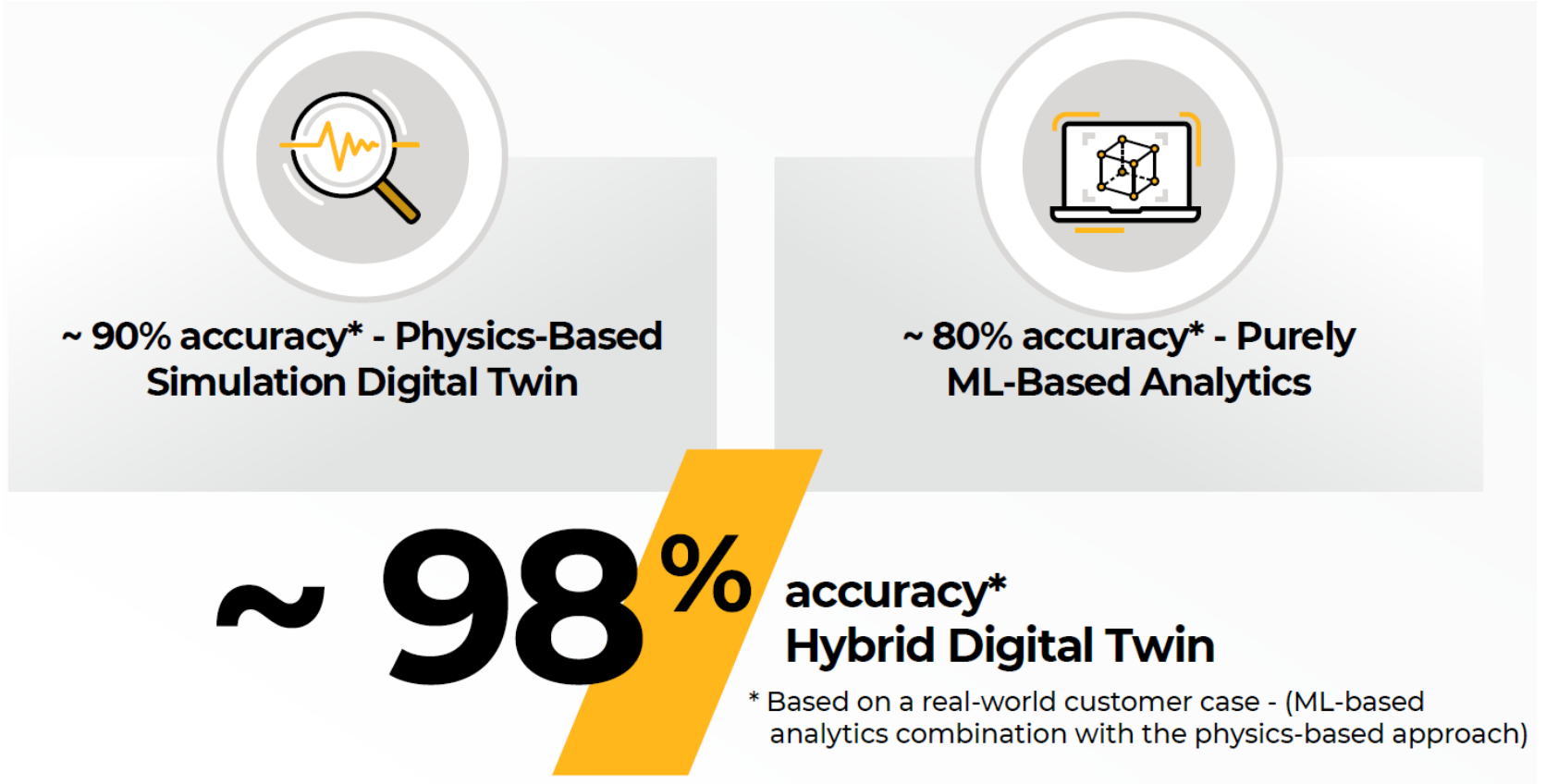
Cover diverse use cases

Easy Online Recalibration

Quickly recalibrate digital twin with online recalibration

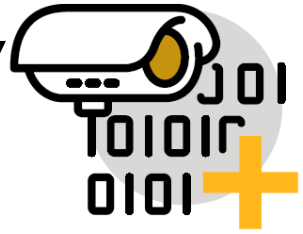
Hybrid Digital Twin: Combine ML-Based Analytics with Physics-Based Approaches to Create Accurate and Evolving Digital Twins

Using hybrid analytics techniques, the resulting hybrid digital twin is more accurate than if using either just data and machine learning of physics simulation alone.



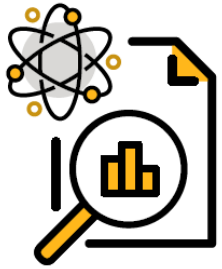
Hybrid Digital Twin Key Benefits

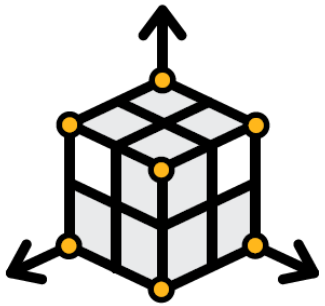
Create virtual sensors to measure missing data



Perform what-ifs before applying a solution

Analyze accurate and deterministic predictions based on physical principles





Explore causality and failure modes using physics

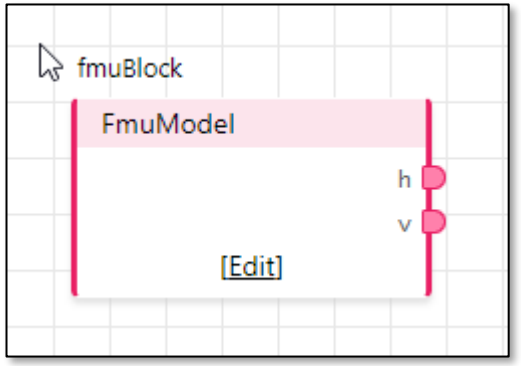
Export and Scaled Deployment

Easily Export and Deploy Digital Twins

Model Exchange (ME) FMU Support in Twin Deployer

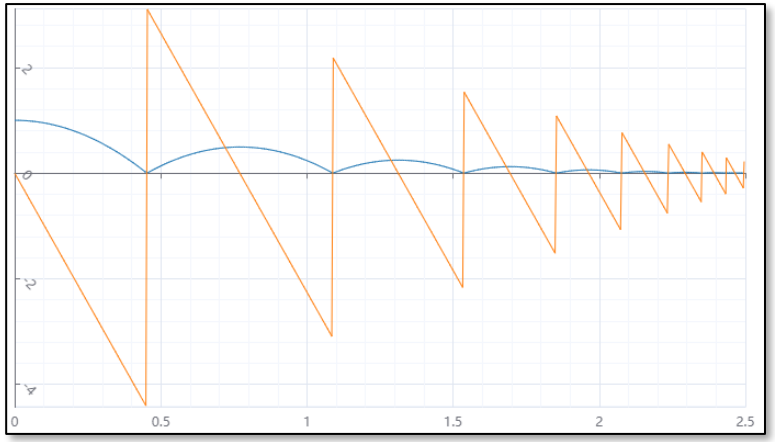
What's New

- Support for FMI 2.0 Model Exchange FMUs



User Benefits

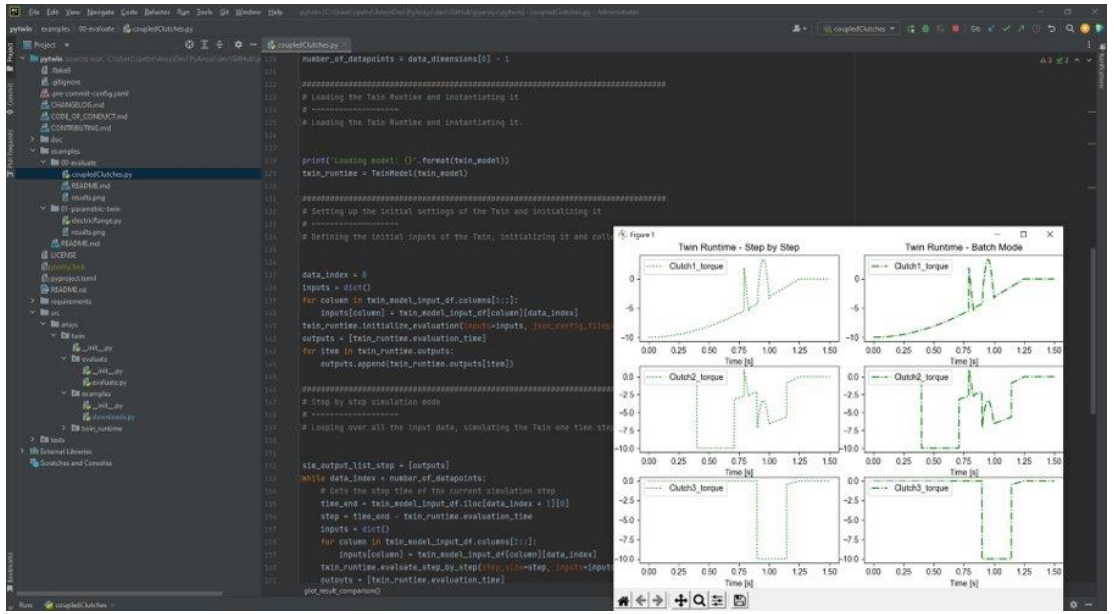
- ME simulation stability has been improved.
- For improved simulation stability, the FMU Sundials CVODE solver is used to perform numerical integration.



Extend API and Automation through PyAnsys/PyTwin

What's New

- Expose deployment workflows to PyAnsys/PyTwin
- Provide new Python workflows for Runtime integration with examples of new use cases (twin consumption, offline twin application, ROM results and connection with Ansys flagships,…)



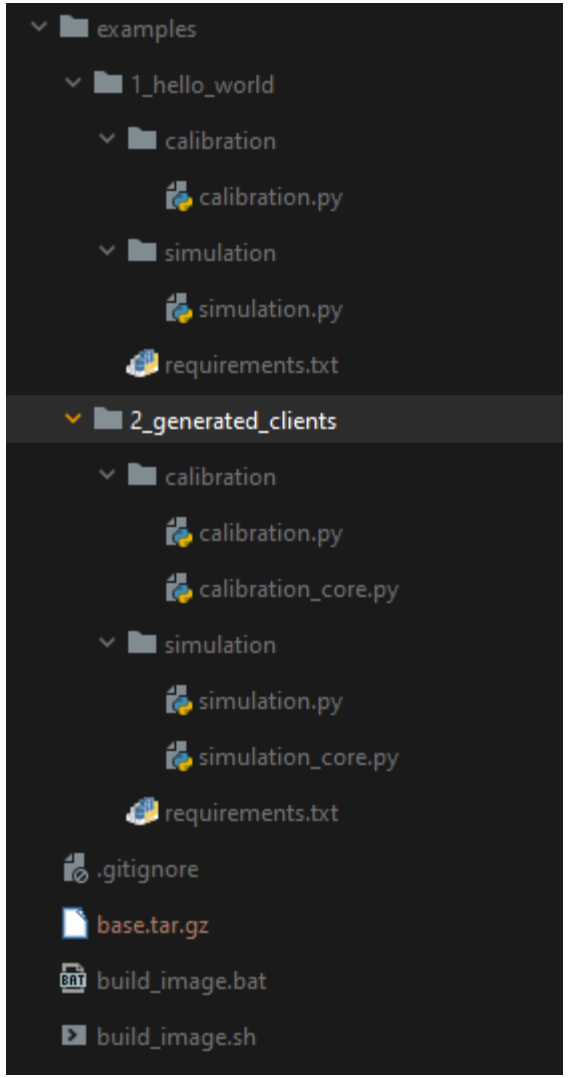
User Benefits

- PyTwin makes it simple to test and automate Twins deployment in Python.
- The SDK API's high-level abstraction makes it even easier to interact with Twin to Initialize/Simulate/Post process the Twins.
- Leverage new workflow opportunities when connecting with Python ecosystem (including other PyAnsys packages)

Easier Scaffolding Code Examples for Getting Started (1/2)

What's New

- Example of auto-generated clients moved to separate folders in Twin Deployer



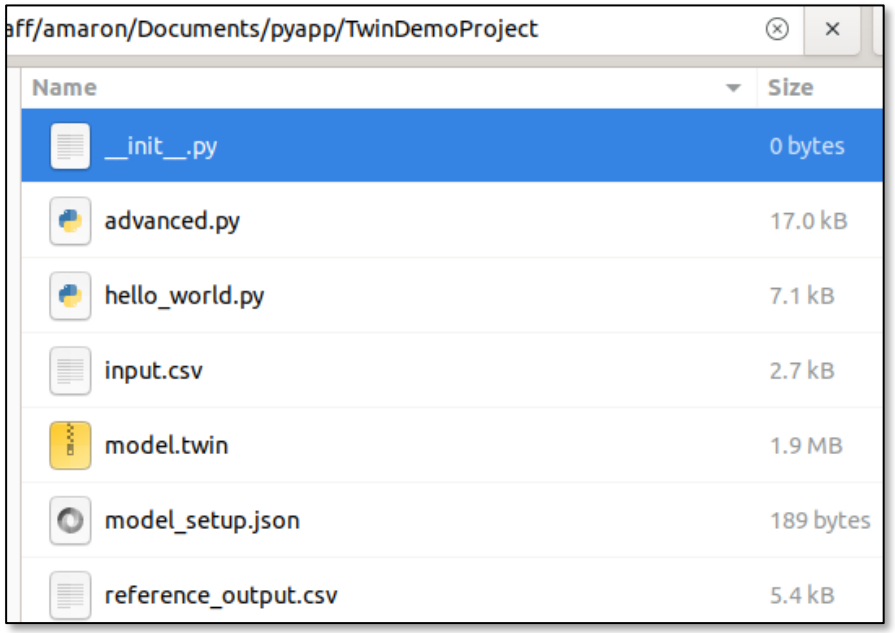
User Benefits

- 1_hello_world
  - Only basic error handling to keep simplicity
  - Easier to understand the API usage
- 2_generated_clients
  - Hides implementation details regarding API endpoints and payloads
  - Common API errors handled by generated clients
  - Focus on application usage rather than on the REST API behavior

Easier Scaffolding Code Examples for Getting Started (2/2)

What's New

- Updates on sample clients
  - A new hello_world.py example for simple and advanced.py for more advanced APIs
  - By default, hello_world.py is executed when executing the run_windows.bat/run_linux.sh scripts
  - Updated some embedded dependencies to ensure compatibility with both Ubuntu20.04 and CentOS7.8/7.9



User Benefits

- 'hello world.py' example contains much simpler sample client code that only runs a Batch Mode CSV simulation (fastest simulation mode)
- Easier for new user to get started with the API

New Improved API Documentation for Deployment

What's New

- New Improved API documentation is exported from Twin Deployer

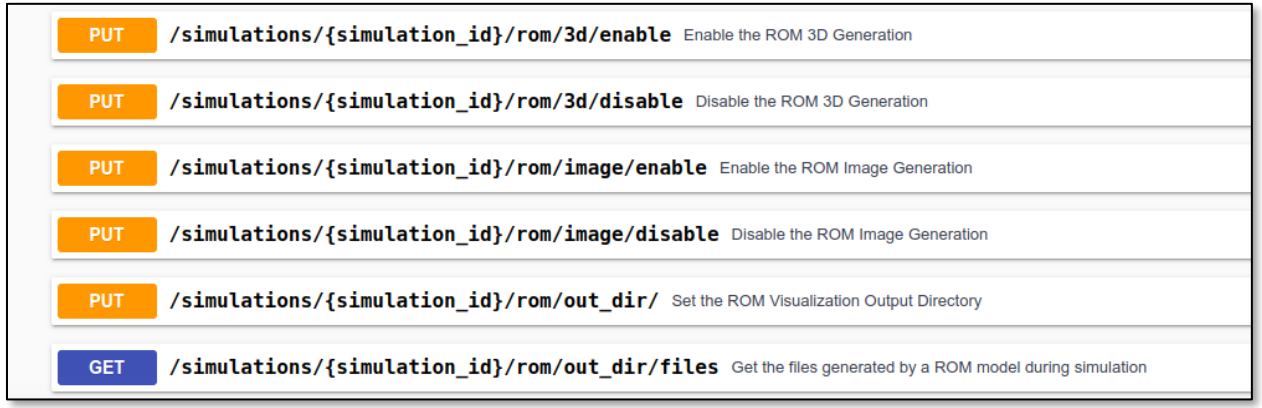
User Benefits

- The new improved style and exported sample code make the documentation more accessible to understand the different APIs and their payloads.

Support for ROM Image Generation in Deployment Package

What's New

- New API endpoints for ROM .modbin/.png file generation and retrieval



User Benefits

- Currently, ROM models require X server and display access from within the container, making .png file generation impossible in headless environments (i.e., cloud). This capability enables it.
- Files are downloaded as .zip file

API Versioning Support in Endpoint URLs

What's New

- API endpoint URLs have been updated to support multiple versioning options, making it easier to maintain legacy client code.

```
localhost:9080/simulation/v1.10.2/simulations
localhost:9080/simulation/v1.10/simulations
localhost:9080/simulation/v1/simulations
```

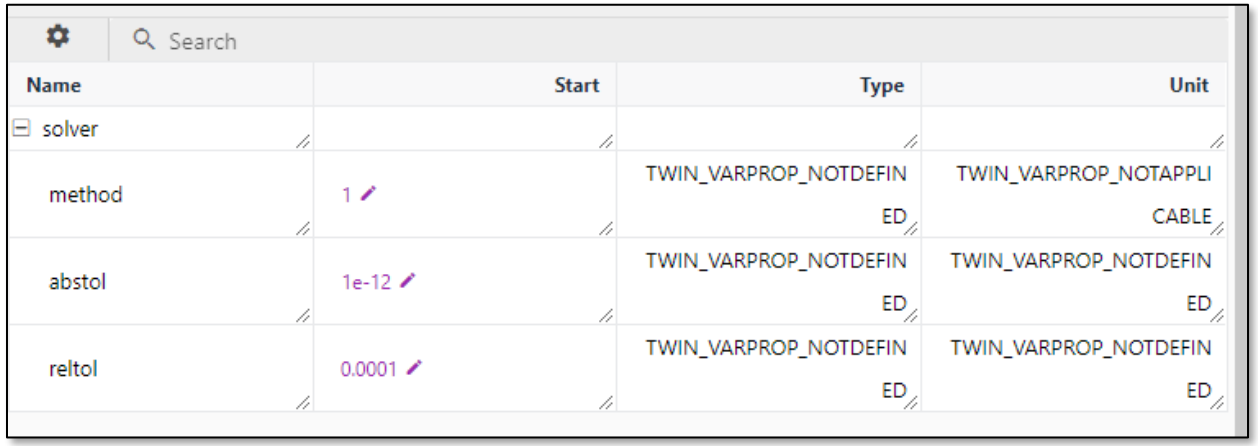
User Benefits

- Customers can deploy containers from multiple Twin Deployer versions without changing their client applications, unless the major versions changes (i.e., a breaking change was introduced)

Twin Deployer: Model Parameter Dialog Enhancements

What's New

- New Model Parameter Dialog enhancement in Twin Deployer



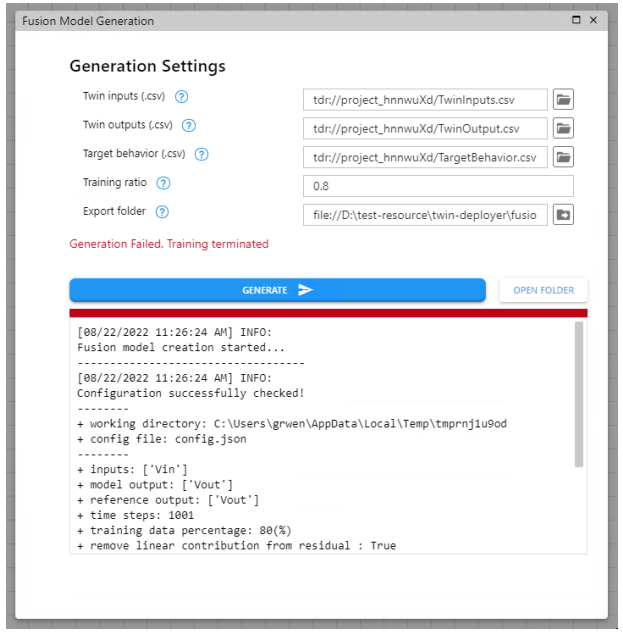
User Benefits

- Model parameter grouping (Twin, FMU) based on name
- The folding and unfolding of the parameter tree structure
- Possibility of searching the parameters
- Column selection capability

Other Enhancements

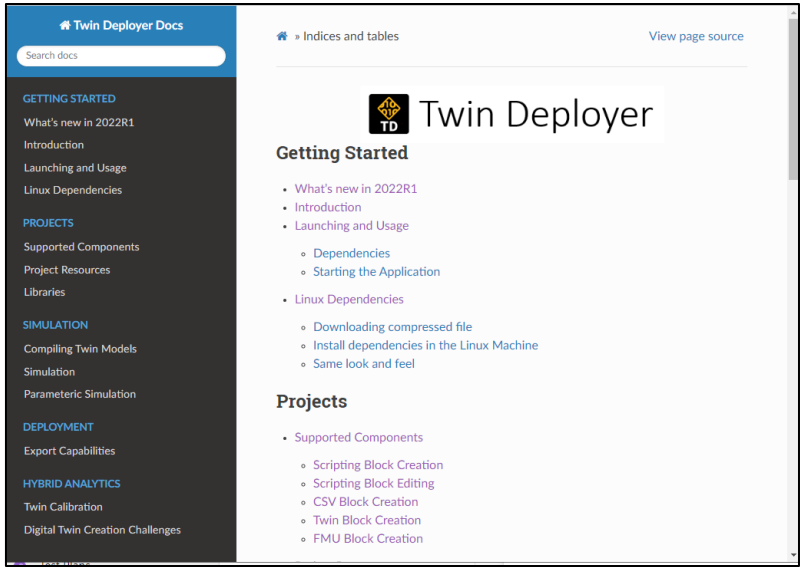
What's New

- Updated Twin Deployer documentation in the installation
- Other Usability enhancements



User Benefits

- Improved usability and stability
- The new improved style makes the documentation easier to access and consume.



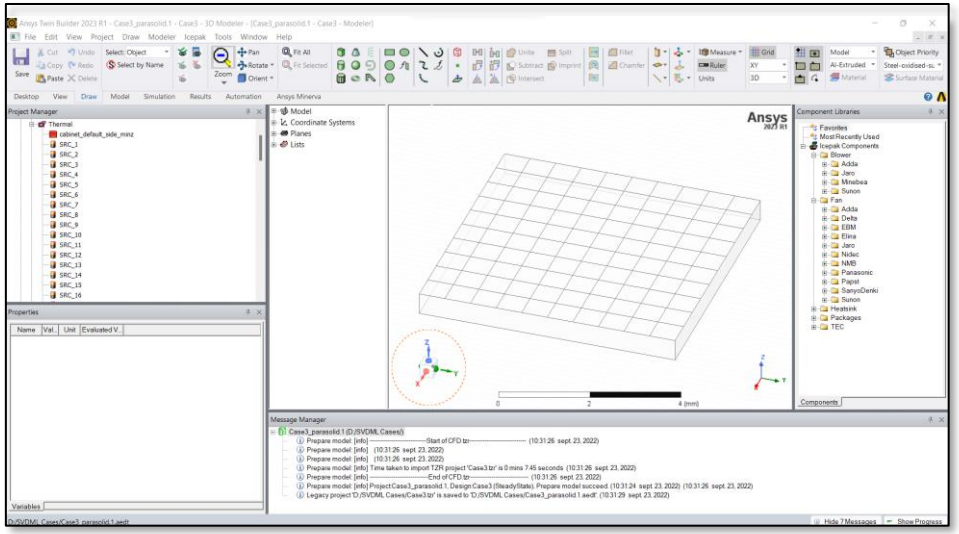
Reduced Order Model

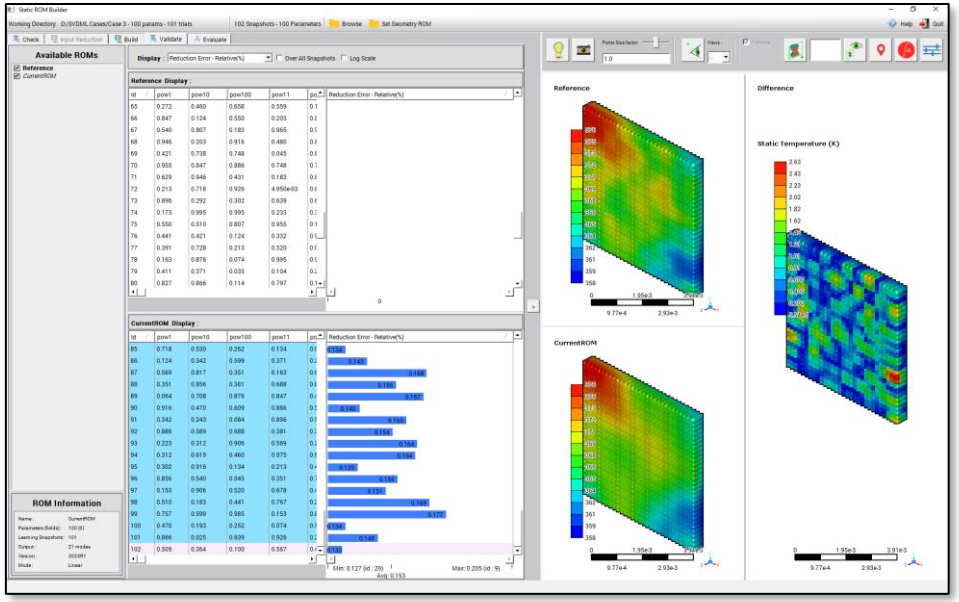
Enhancements to Reduced Order Model and Workflows

New Linear Static ROM that handles a large number of parameter

What's New

- New Linear Static ROM that handles a large number of parameter





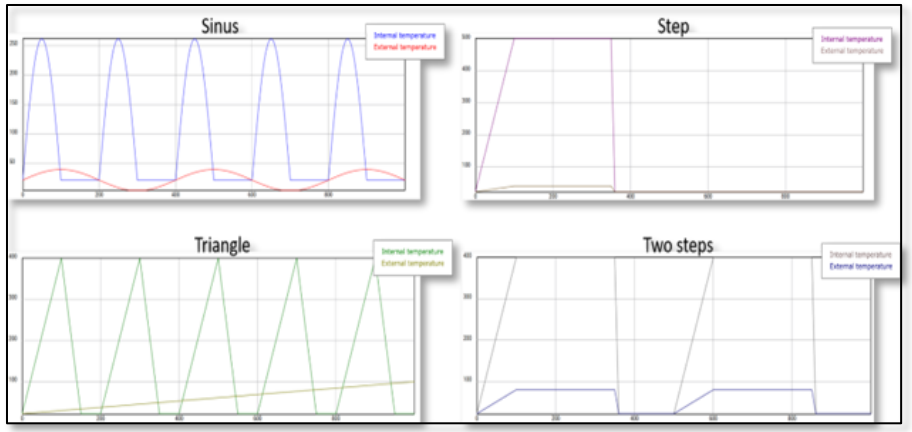
User Benefits

- Ideal for Electronics/Thermal applications, but also applicable to other problems.
- To characterize an n-parameter problem, a linear problem requires only n+1 snapshots.

New Linear Dynamic ROM (Linear TDVF)

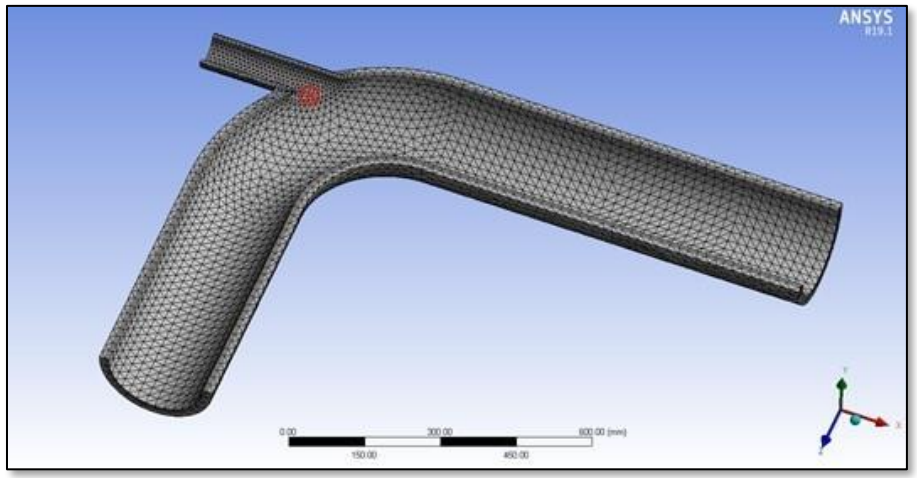
What's New

- New Linear Dynamic ROM Linear TDVF (Linear Time Domain Vector Fitting)



User Benefits

- Linear TDVF is a very effective linear dynamic ROM algorithm making simulation much faster
- The trapezoidal rule is used for convolution making it very robust
- Field inputs are also supported.



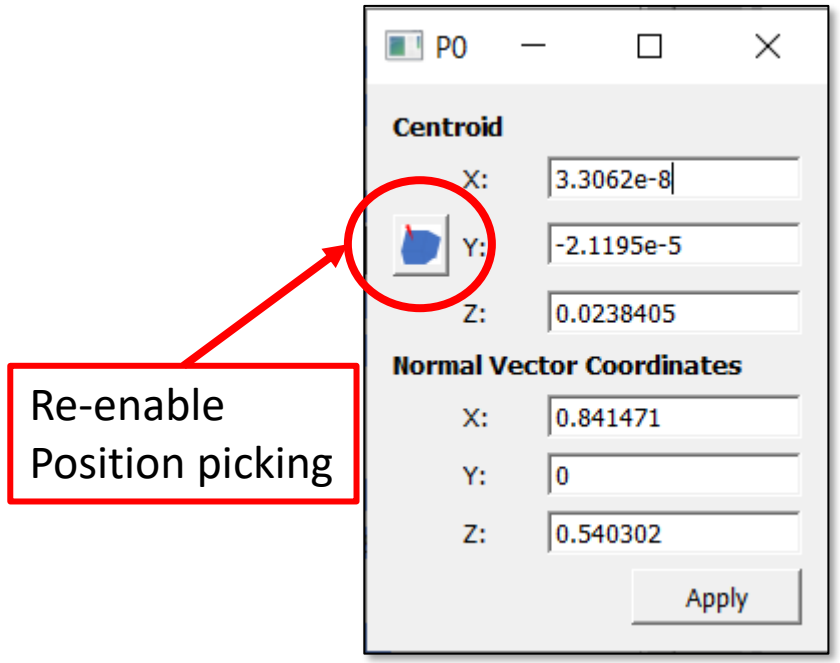
Cut-plane coordinate Specification by Orientation and Origin

What's New

- Improved Cut-plane Coordinate Specification by Orientation and Origin
- Generate a cut-plane by click (with mouse)
- Ability to edit its orientation and origin using UI

User Benefits

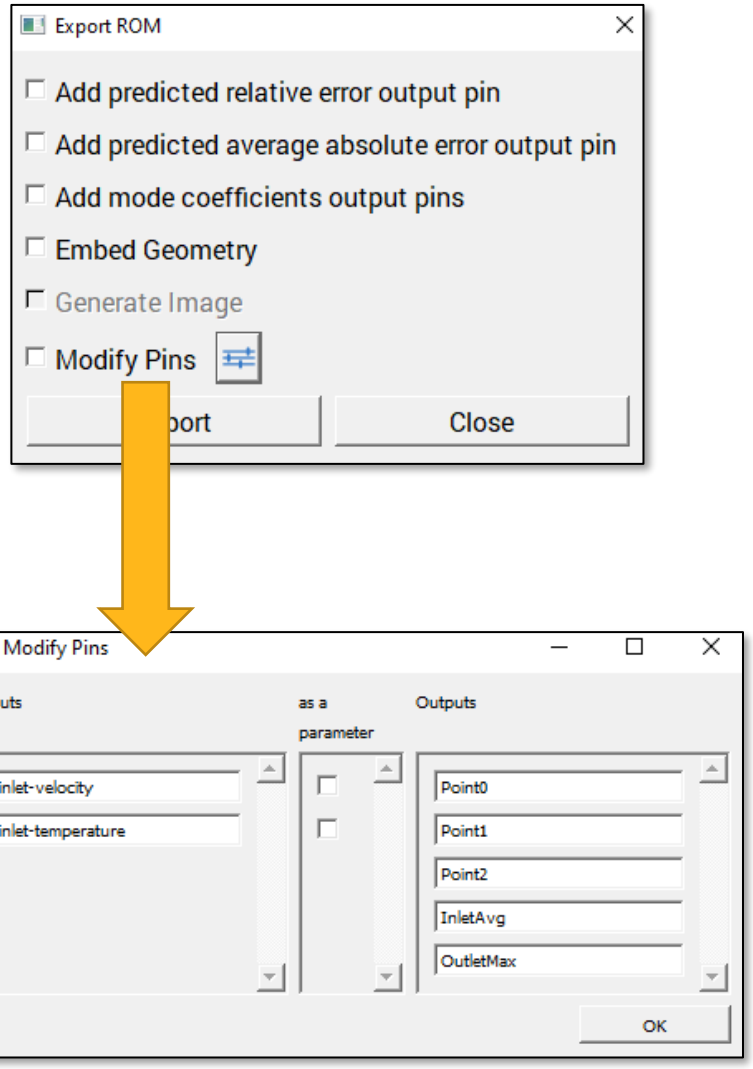
- Easier and better control of cut-plane coordinate specification with mouse and UI



Improved Workflow for Renaming Input/Output Pins for ROMs

What's New

- Improved Workflow for renaming Input/Output Pins for ROMs



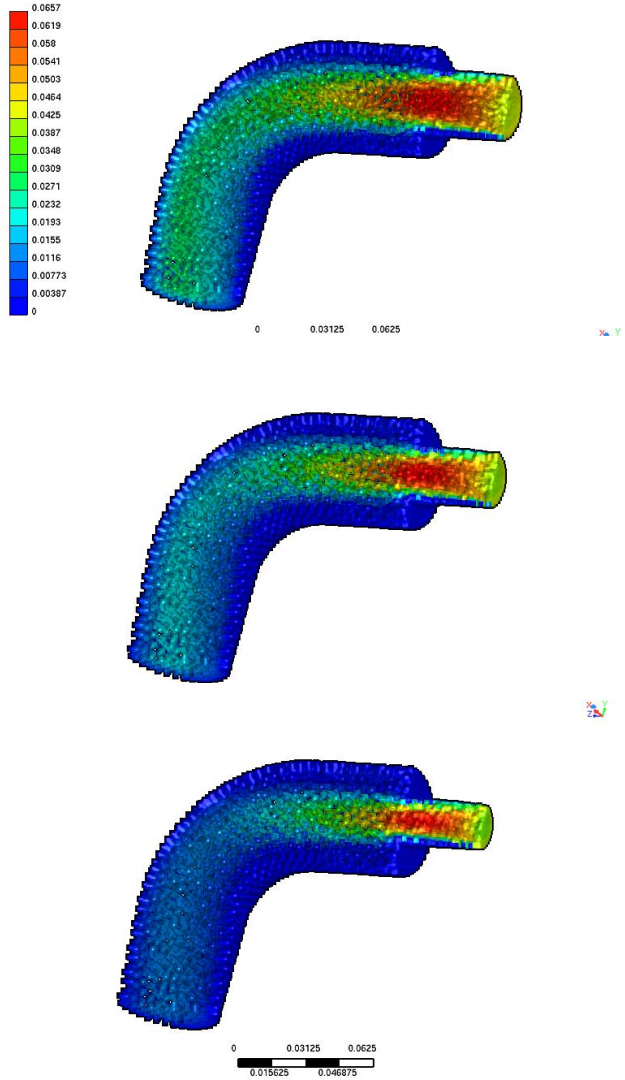
User Benefits

- The ability to rename each pin (input and output) at export-time.
- At export-time, you can specify whether a ROM input parameter will be considered as an input or parameter (e.g., for hybrid calibration) for the exported model.

Image Generation with Geometry Deformation

What's New

- Image Generation with Geometry Deformation



User Benefits

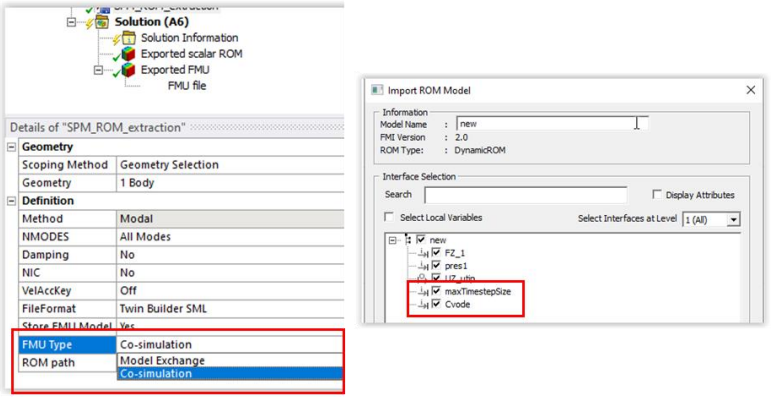
- Geometry deformation support for image generation allows users to generate images from ROM and Twins.

Improvements on SPM ROM/Modal ROM Export from Mechanical

What's New

- SPM ROM/Modal Field ROM for Mechanical to Twin Builder Improvements
  - Include highest frequency value in the FMU export to suggest Max timestep in Twin Builder
  - Include solver type in the FMU/TBROM export (Model Exchange or Co-simulation)

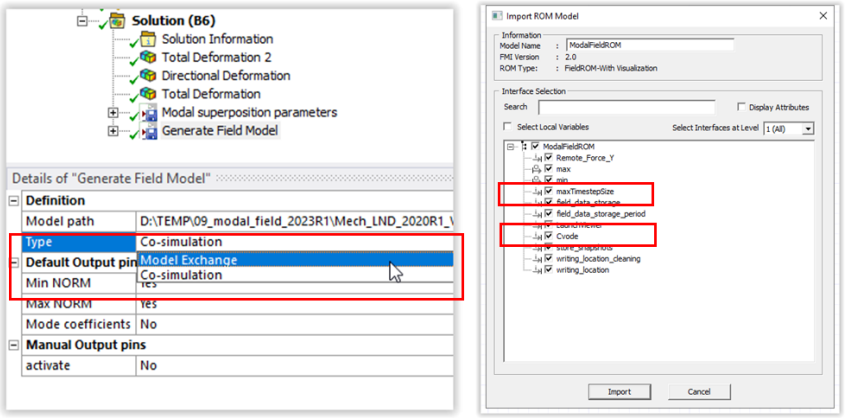
SPM ROM extension



User Benefits

- Better usability and less error prone
- Improved stability

Modal field extension



Model Building – Modelica

Enhancements to the Modelica workflow

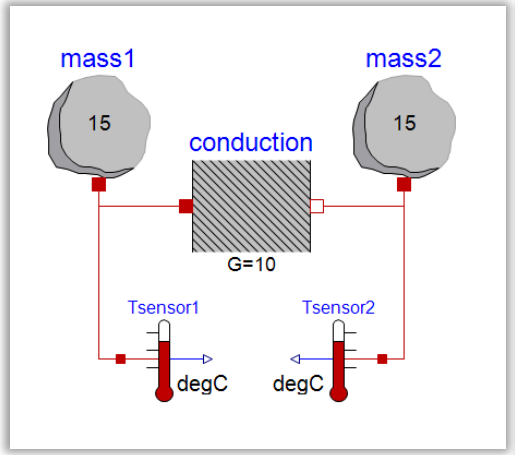
Modelica: Enhanced Diagram Graphics

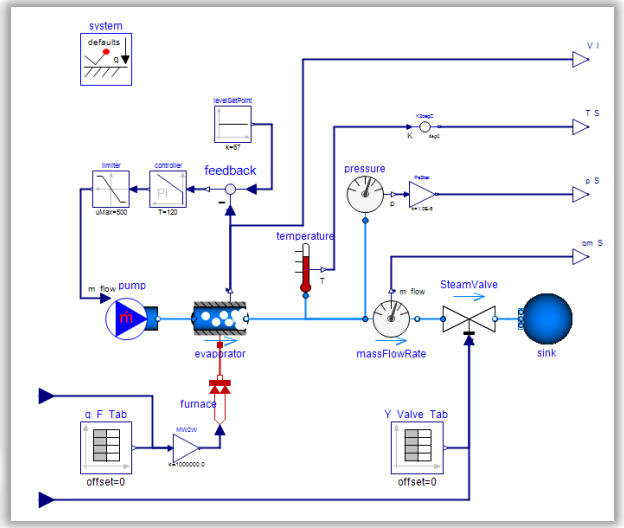
What's New

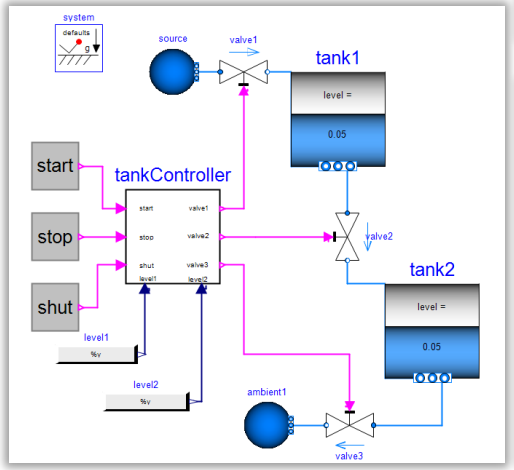
- Modern and Enhanced Graphics in Modelica Editor
  - Support for Gradient fill in component icons
  - Support for Anti-Aliasing and transparency in images
  - Support for different pattern styles and line styles
  - Improved drawing for text in icons

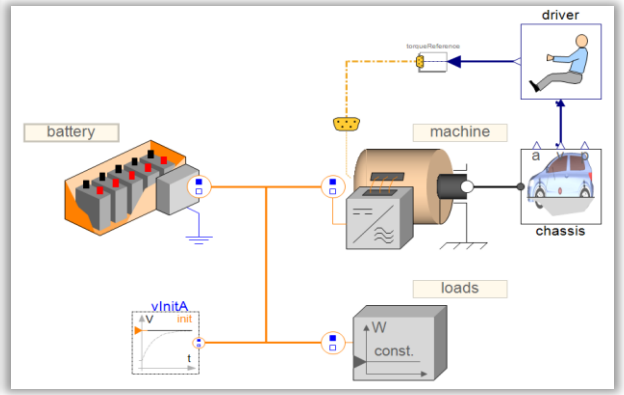
User Benefits

- Better graphics support conforms the graphics to the Modelica standard.
- It is now possible to import libraries with advanced graphics features.









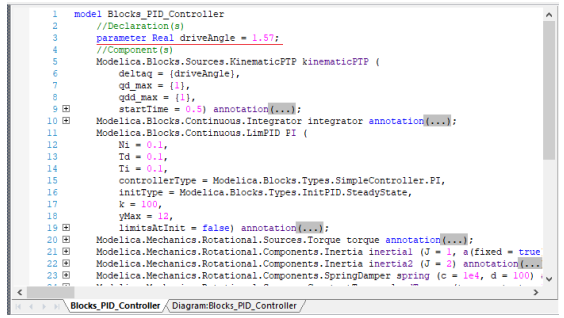
Improved Bijection in Modelica Text Editor

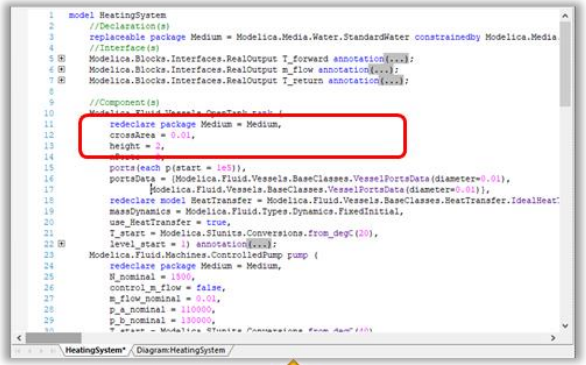
What's New

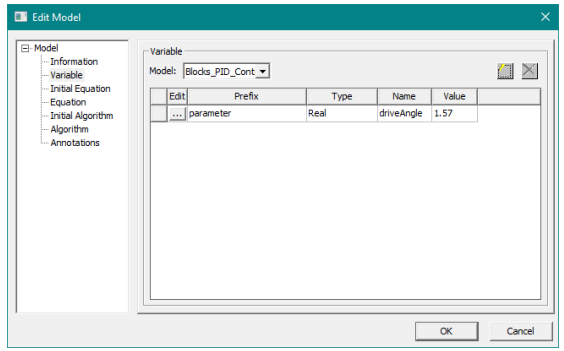
- Add new parameters or modify existing outputs in Text Editor
- Support for component parameter modification in Text Editor
- Support for "Extend" model from library in Text Editor

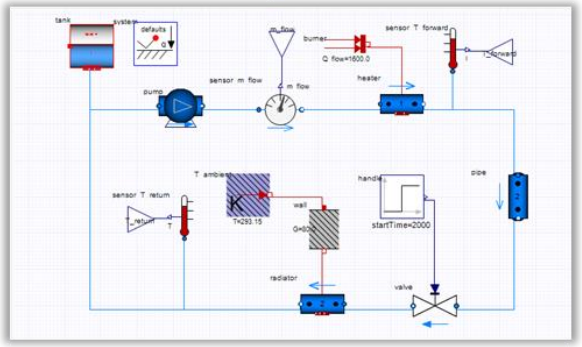
User Benefits

- The capability allows you to make direct design changes in either text or diagram view and have them reflected in the alternate view.
- Make Modelica model creation faster and preserver changes across both views.









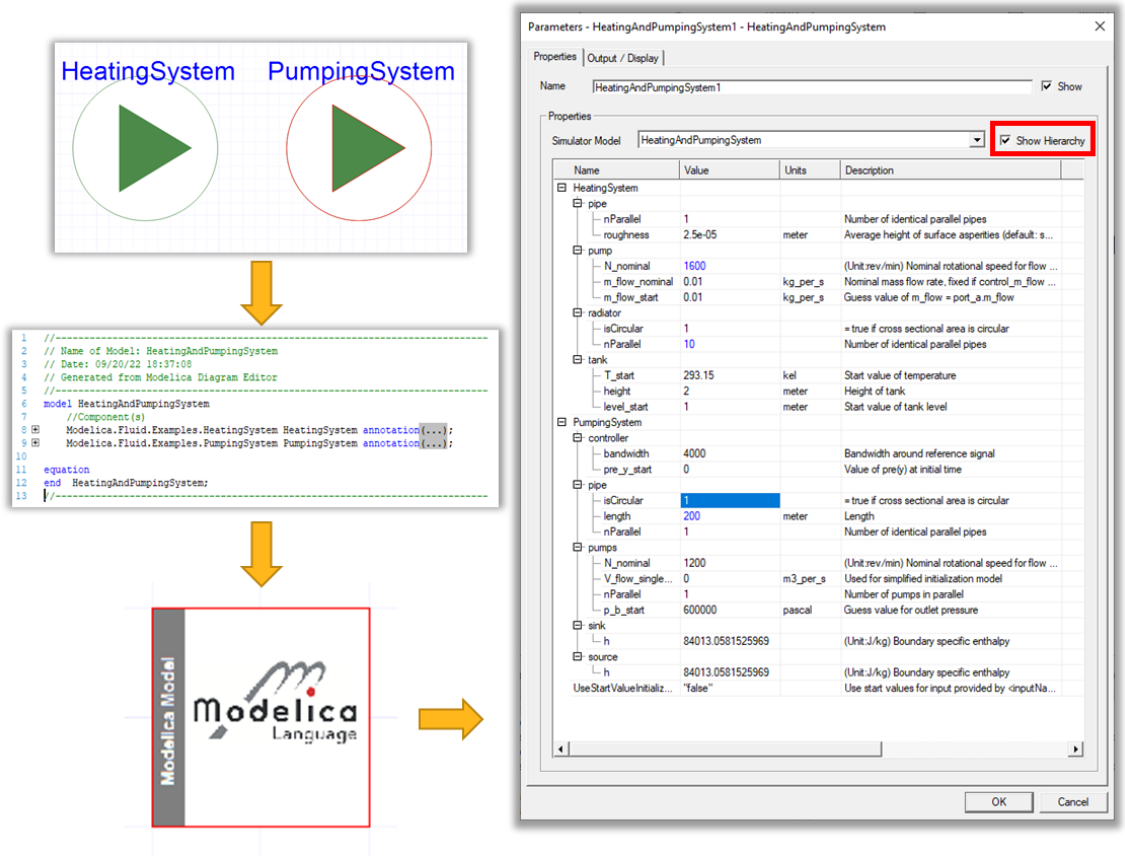
Modelica: Hierarchical Display and Editing of Parameters

What's New

- Hierarchical Display of Parameters
  - Internal parameters can be exposed in Modelica and other FMUs using the dot notation
  - Component dialog now supports ability to show selected internal parameters as a multi level tree control

User Benefits

- Improves usability and readability



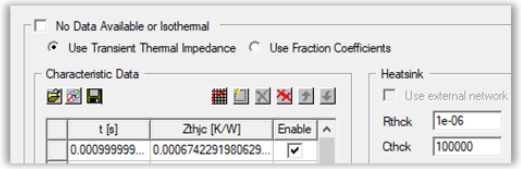
Solver and Model Library

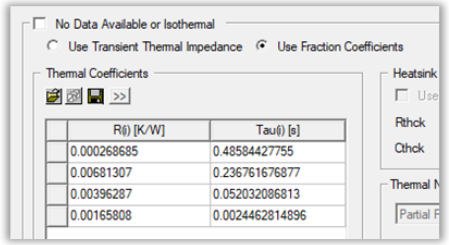
Enhancements in Solver and Model Library

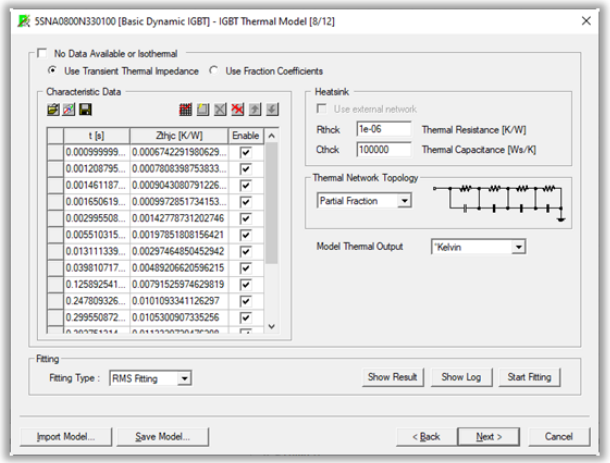
Usability Improvements for Device Characterization Wizard

What's New

- Simplified Thermal Fitting Page
- New selection of Fitting Type
- Simplified Selection of Channel Type

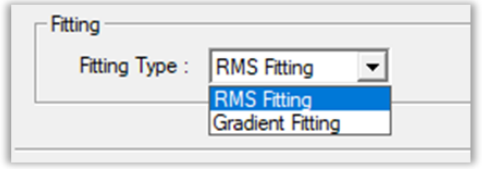


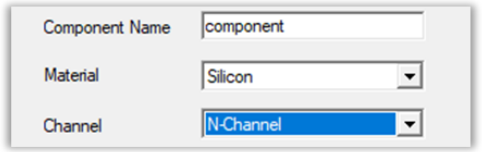




User Benefits

- Better usability
- Gradient fitting is a new option that work better in some cases
- More intuitive selection for choosing the channel type

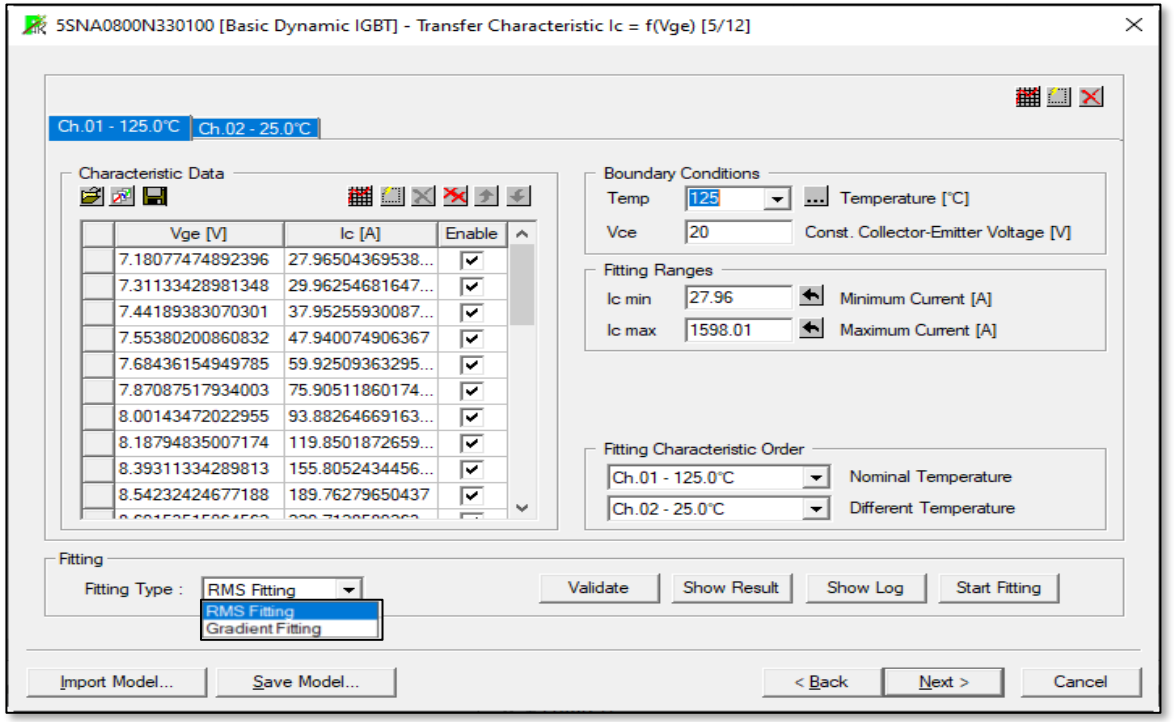




Support for Gradient Fitting in Device Characterization

What's New

- Support for Gradient Fitting in Device Characterization



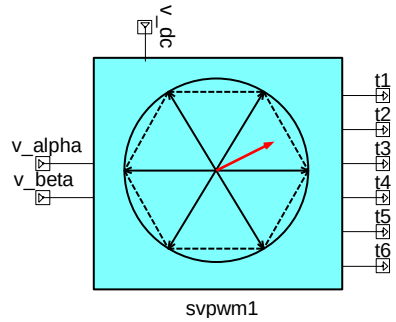
User Benefits

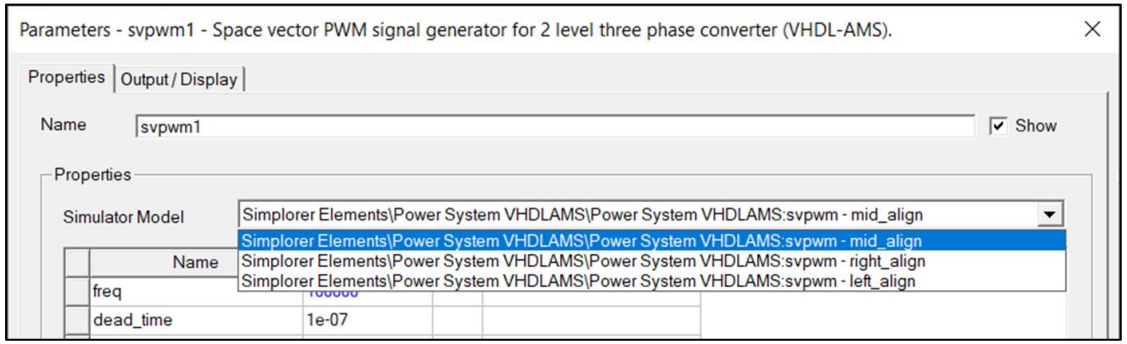
- In some cases, it is advantageous to use Gradient Fitting instead of RMS Fit:
  - Results are not satisfying, or fitting takes too much time.
  - Some model parameters run out of the expected scope.
  - Simulation using the final component shows convergence issues.
  - Find the best compromise of a general unsatisfactory fitting result.

New Carrier Wave Options in the SVPWM Component

What's New

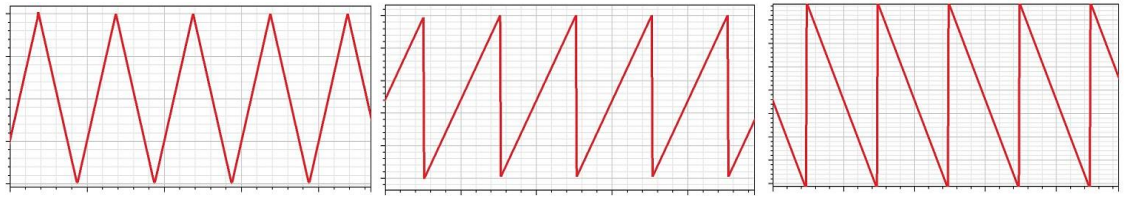
- New Carrier Wave Options in the SVPWM Component





User Benefits

- This new option of carrier wave allows for all three options:
  - mid_align – triangle source for carrier wave.
  - right_align – right sawtooth source for carrier wave.
  - left_align – left sawtooth source for carrier wave.



Enhancements for MATLAB Workflows

What's New

- Simulink Co-simulation update in Twin Builder
  - Added support for MATLAB versions R2021b and R2022a.
  - Removed older versions R2017b and R2018a.
- LTI toolkit export for MATLAB now contains information for input and output name and reference values

```
% Input_vec = [
% input_1
% input_2
% Ref_output1 = refVal
% Ref_output2 = refVal
% ]

% Output_vec = [
% output1
% output2
% ]
```

User Benefits

- Additional information has been added to the m-file to better support MATLAB users.
- Easier reuse of LTI-ROMs in MATLAB/Simulink

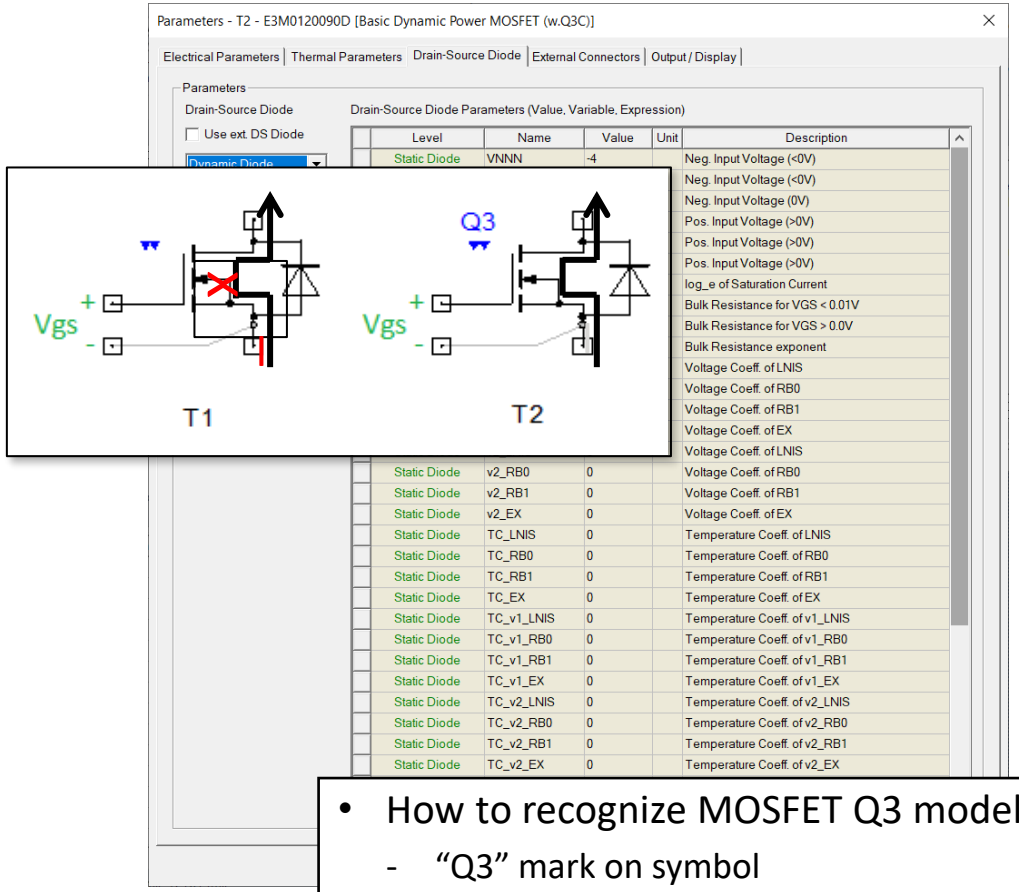
New Basic Dynamics MOSFET Model with Q3 control (Beta)

What's New

- New Basic Dynamics MOSFET Model with Q3 control (Beta)
- Q3 model can only be generated by Characterization Wizard through a special workflow
- Regular wizard workflow still generate the old MOSFET model with no reverse conduction

User Benefits

- Regular MOSFET models in TB cannot conduct reverse current through transistor and a new basic dynamic model MOSFET_Q3 is added to solve this limit



- How to recognize MOSFET Q3 model
  - "Q3" mark on symbol
  - "(w. Q3C)" on component parameter page
  - Extended list of static parameters in tab "Drain-Source Diode"

General UI/UX Enhancements

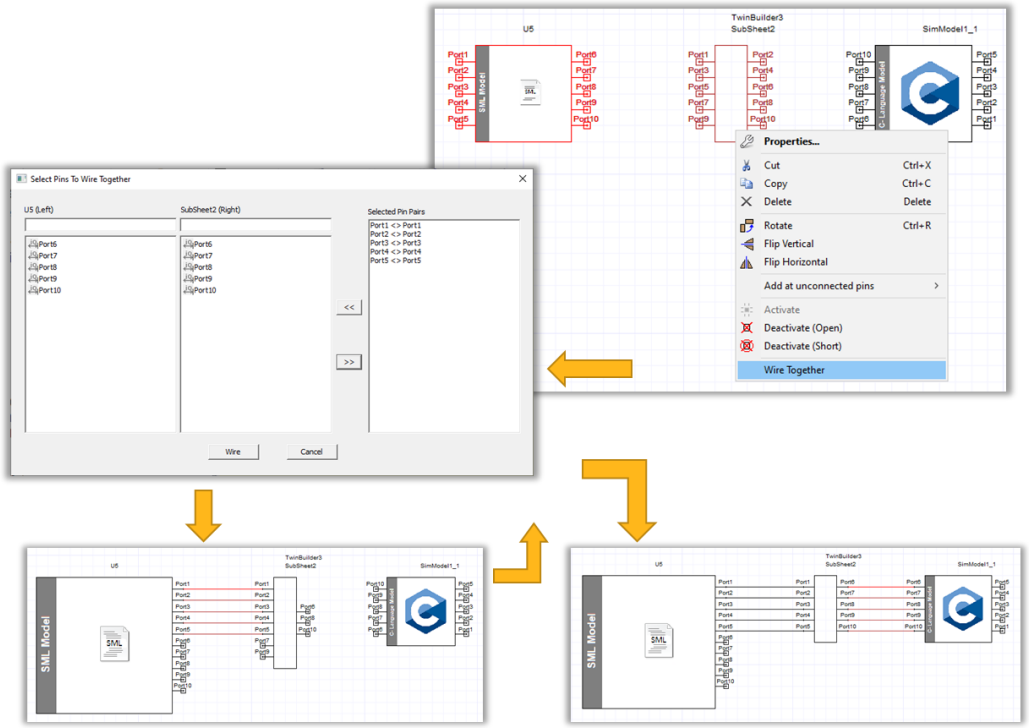
Wire Together: Easier Pin Connection for Large Components

What's New

- Wire Together Two Large Components with the help of UI
- Supports pins with direction (in, out)
- Allows Filtering on large pin list
- Works also with rectangular symbols
- Multi select to connect many pins

User Benefits

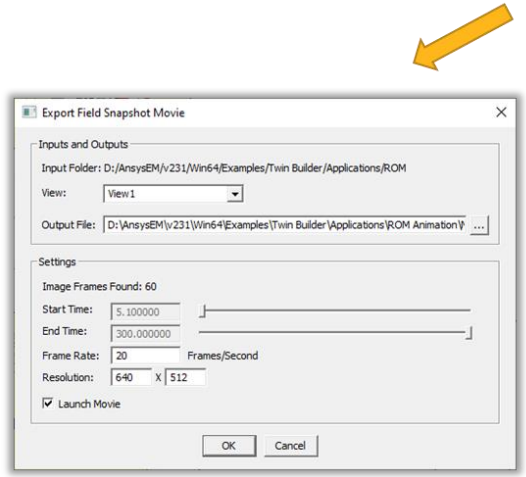
- Improved usability for connecting components, particularly those with large number of input and output pins

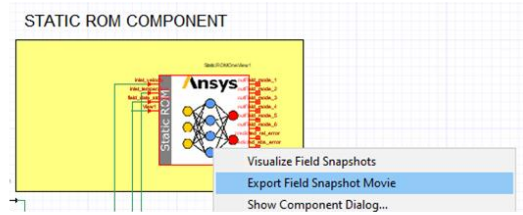


Twin Builder ROM Animation Video Export

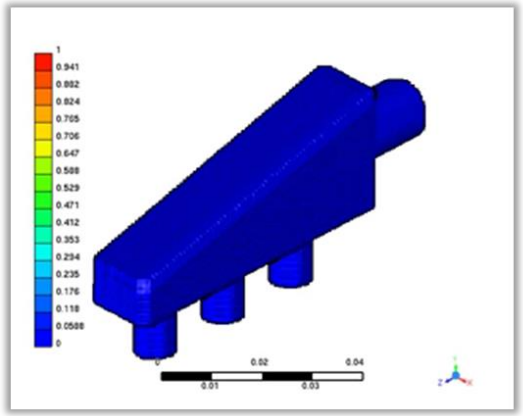
What's New

- Export ROM Field Snapshot Animation as a movie
- New Script Command ExportAsMovie() is also available





Exported Movie File



User Benefits

- Easily create and share ROM animation from Twin Builder

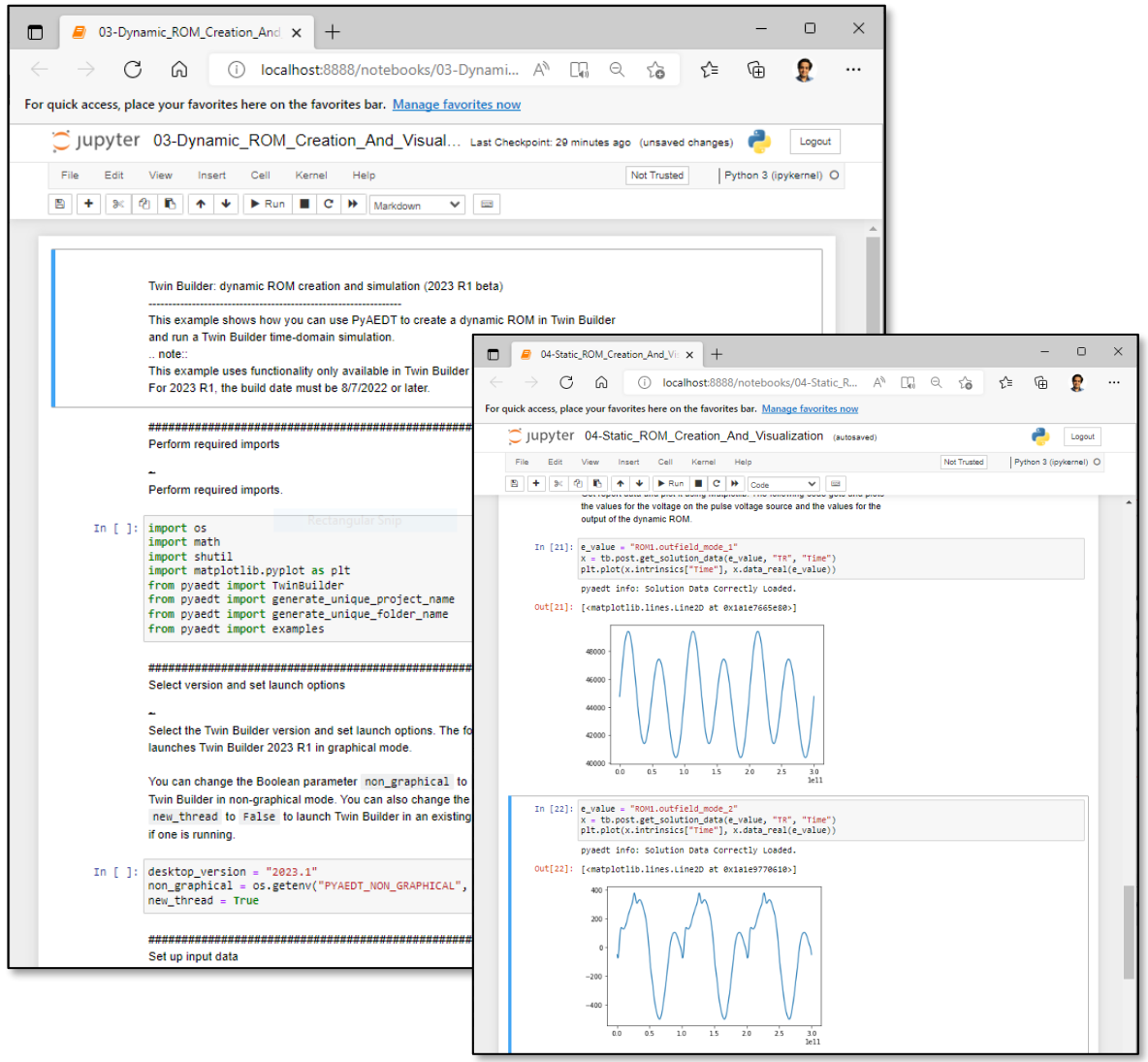
Automation with pyAnsys/pyAEDT: ROM creation using python

What's New

- New example for creating Static ROM and Dynamic ROM

User Benefits

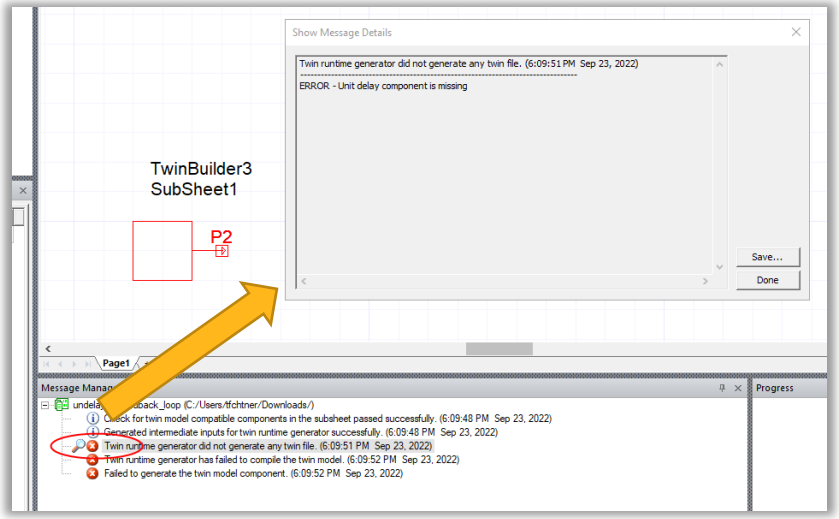
- Scripting examples on GitHub/pyAnsys can run on command line or in a Jupyter Notebook
- Automate workflows for easier ROM creation



Easy Debug and Error Log Access

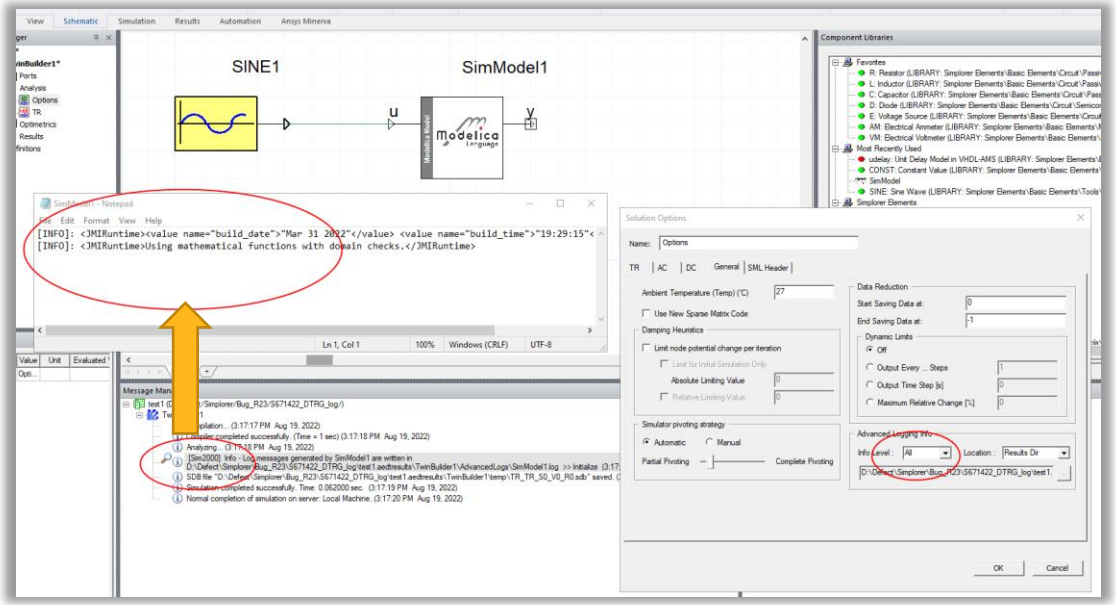
What's New

- Twin Generation Log
- Advanced log for Simulation



User Benefits

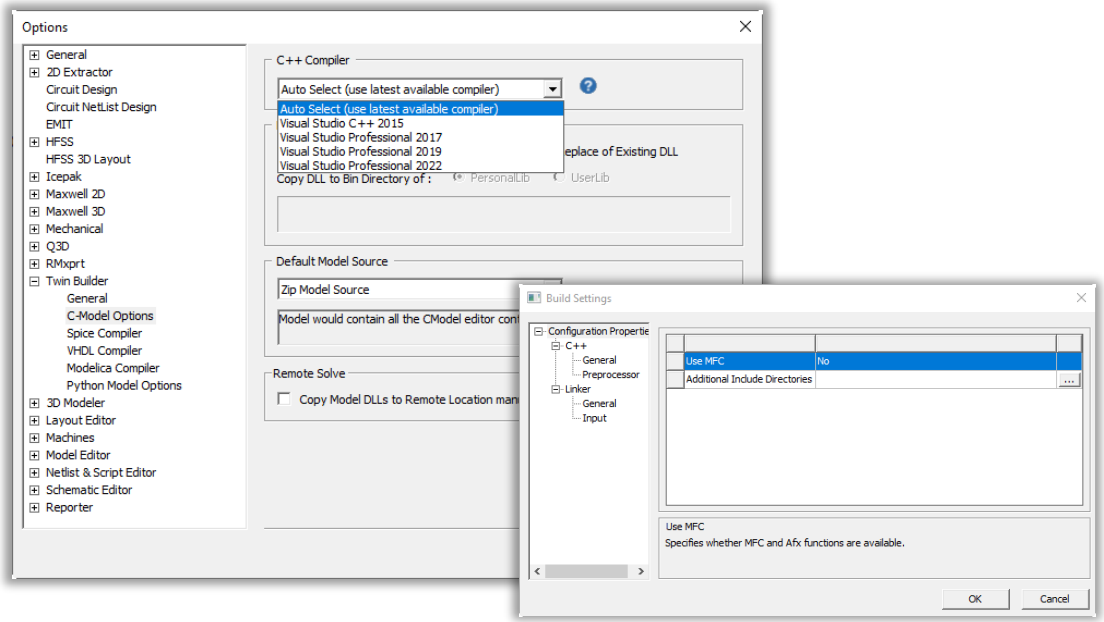
- Magnify icon now shows a detailed log window
- Easy access to debug and logs for easier debugging



Compiler Upgrades for 2023 R1

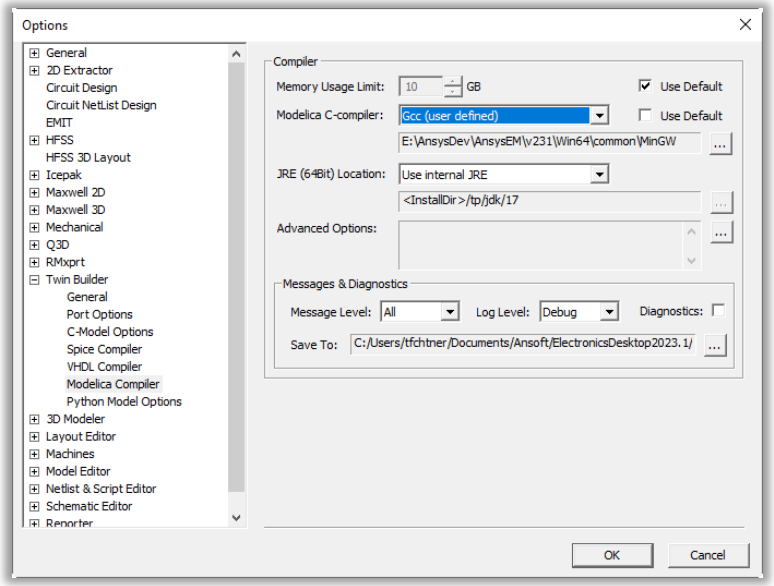
What's New

- Compiler Upgrades for 2023 R1 (Visual C++ 2022)
- Modelica users can now use an external version of GCC for compilation of Modelica models



User Benefits

- Added Support for Visual C++ 2022
  - Modelica support stays at Visual C++ 2019 for now
  - Support for Visual C++ 2013 dropped
  - Installation of MFC libraries now optional and off by default
  - Available for C-model, VHDL and Python models




Ansys